

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT7348364

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MIN GON LEE	01/05/2020
TAEK JUNG LEE	01/05/2020
JIN MAN JUNG	01/05/2020
JIN KYUNG JOO	01/05/2020
JI HONG JO	01/05/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SAMSUNG ELECTRO-MECHANICS CO., LTD.
<b>Street Address:</b>	MAEYOUNG-RO 150 (MAETAN-DONG), YOUNGTONG-GU
<b>City:</b>	SUWON-SI, GYEONGGI-DO
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17752179
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)739-3001
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	2027393000
<b>Email:</b>	patents@morganlewis.com, christine.peoples@morganlewis.com
<b>Correspondent Name:</b>	HOSANG LEE
<b>Address Line 1:</b>	MORGAN, LEWIS & BOCKIUS LLP
<b>Address Line 2:</b>	1111 PENNSYLVANIA AVENUE NW
<b>Address Line 4:</b>	WASHINGTON, D.C. 20004
<b>ATTORNEY DOCKET NUMBER:</b>	123193-8785-US
<b>NAME OF SUBMITTER:</b>	RAYMAR FARID
<b>SIGNATURE:</b>	/raymar farid/
<b>DATE SIGNED:</b>	05/25/2022
<b>Total Attachments: 3</b>	
source=123193-8785-US-Declaration-Assignment#page1.tif	
source=123193-8785-US-Declaration-Assignment#page2.tif	



## Title of Invention

## DECLARATION

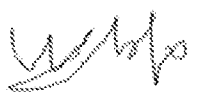
This declaration  
is directed to:

X

☐

## ASSIGNMENT



NAME OF INVENTOR (Full Legal Name) : <u>Ji Hong JO</u>	
Signature: <u></u>	Date: <u>2020. 1. 5</u>

mq12.lee

*Morgan, Lewis & Bockius LLP*